



US00D926035S

(12) **United States Design Patent**
Saule et al.

(10) **Patent No.:** **US D926,035 S**
(45) **Date of Patent:** **** Jul. 27, 2021**

- (54) **PACKAGING FOR HEADPHONES**
- (71) Applicant: **Dolby Laboratories Licensing Corporation**, San Francisco, CA (US)
- (72) Inventors: **Lucas E. Saule**, San Francisco, CA (US); **Grayson H. Byrd**, San Francisco, CA (US); **Peter Michaelian**, San Francisco, CA (US); **Cody M. Proksa**, San Francisco, CA (US); **Vincent Voron**, Menlo Park, CA (US)
- (73) Assignee: **Dolby Laboratories Licensing Corporation**, San Francisco, CA (US)

- 3,467,245 A * 9/1969 Akiko B65D 81/113
206/738
- D321,054 S 10/1991 Cohn
- 6,298,989 B1 * 10/2001 Chu B65D 81/025
206/320
- D723,920 S 3/2015 Wakeham et al.
- D749,417 S 2/2016 Bate et al.
- D889,967 S * 7/2020 Glass D9/456
- D897,210 S * 9/2020 Saule D9/456
- 2012/0031798 A1 * 2/2012 DesLauriers B65B 25/001
206/524.1
- 2013/0118944 A1 5/2013 Niiro et al.
- 2013/0233745 A1 9/2013 Tierney et al.
- 2014/0014537 A1 1/2014 Eshetu et al.
- 2015/0209129 A1 7/2015 Bailly et al.

(**) Term: **15 Years**

(21) Appl. No.: **29/746,198**

(22) Filed: **Aug. 12, 2020**

Related U.S. Application Data

(63) Continuation of application No. 29/662,729, filed on Sep. 7, 2018, now Pat. No. Des. 897,210.

(51) **LOC (13) Cl.** **09-07**

(52) **U.S. Cl.**
USPC **D9/456; D9/424**

(58) **Field of Classification Search**
USPC D9/414, 418, 419, 420, 422, 423, 424,
D9/425, 426, 432, 456, 737, 751
CPC B65D 5/5213; B65D 75/36; B65D 81/113;
B65D 5/4204; B65D 75/58; B65D 65/38;
B65D 73/0035; B65D 2585/86
See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

- 3,124,246 A * 3/1964 de Remer et al. B65D 77/32
229/235
- 3,415,364 A * 12/1968 Schneider B65D 81/113
206/524

Primary Examiner — Lauren R Calve

(74) *Attorney, Agent, or Firm* — Saidman DesignLaw Group, LLC

(57) **CLAIM**

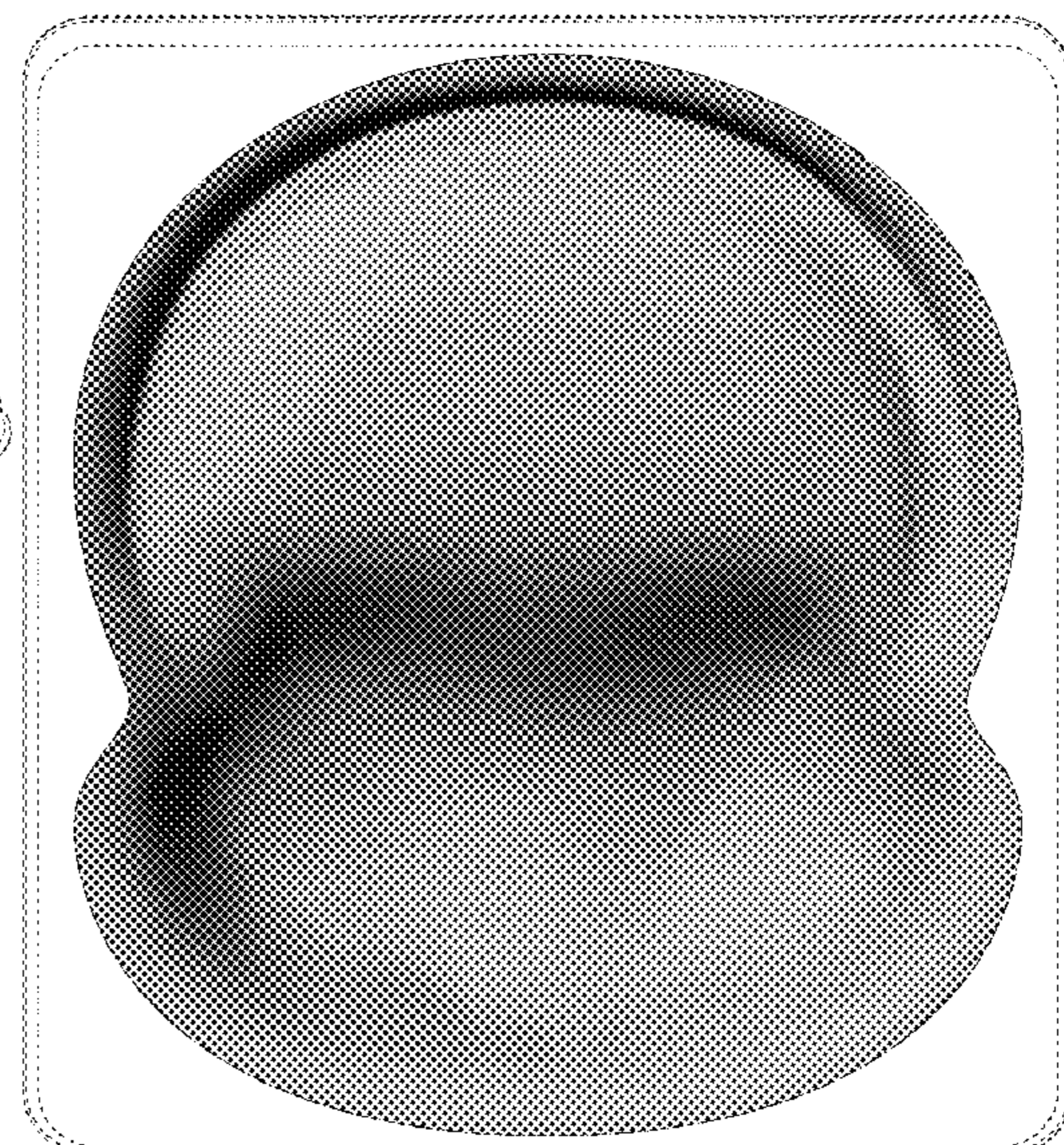
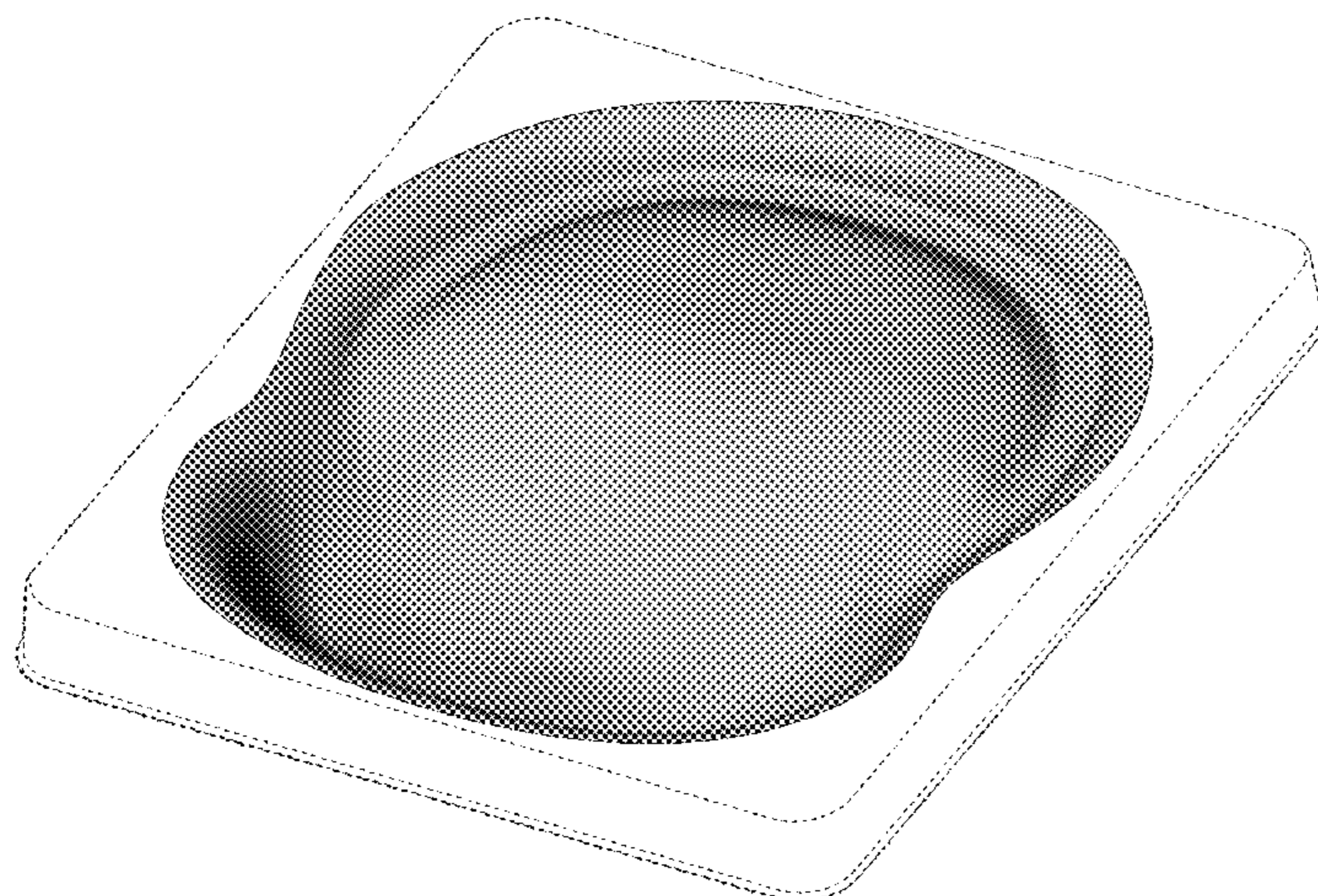
The ornamental design for packaging for headphones, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of packaging for headphones showing our new design;
 FIG. 2 is a front view thereof;
 FIG. 3 is a rear view thereof;
 FIG. 4 is a left side view thereof;
 FIG. 5 is a right side view thereof;
 FIG. 6 is a top view thereof; and,
 FIG. 7 is a bottom view thereof.

In FIGS. 1-7, grayscale shading illustrates contour.
 In FIGS. 1-7, the dashed broken lines illustrate structure or features which form no part of the claimed design and the dot-dash broken lines illustrate boundaries which form no part of the claimed design.

1 Claim, 5 Drawing Sheets



(56)

References Cited

U.S. PATENT DOCUMENTS

2018/0079579 A1 3/2018 Chen
2018/0251286 A1 9/2018 Rehders et al.

* cited by examiner

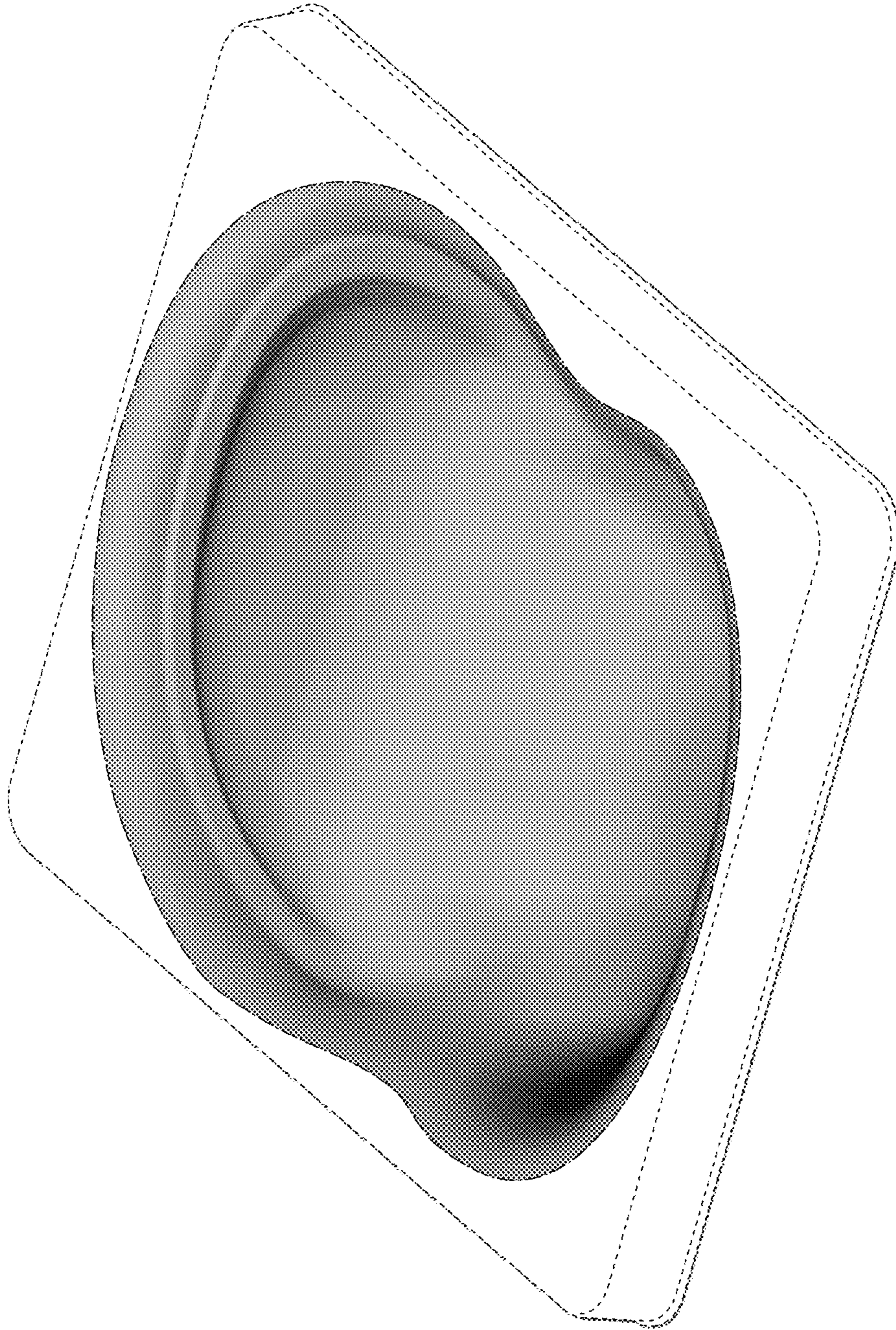


Fig. 1

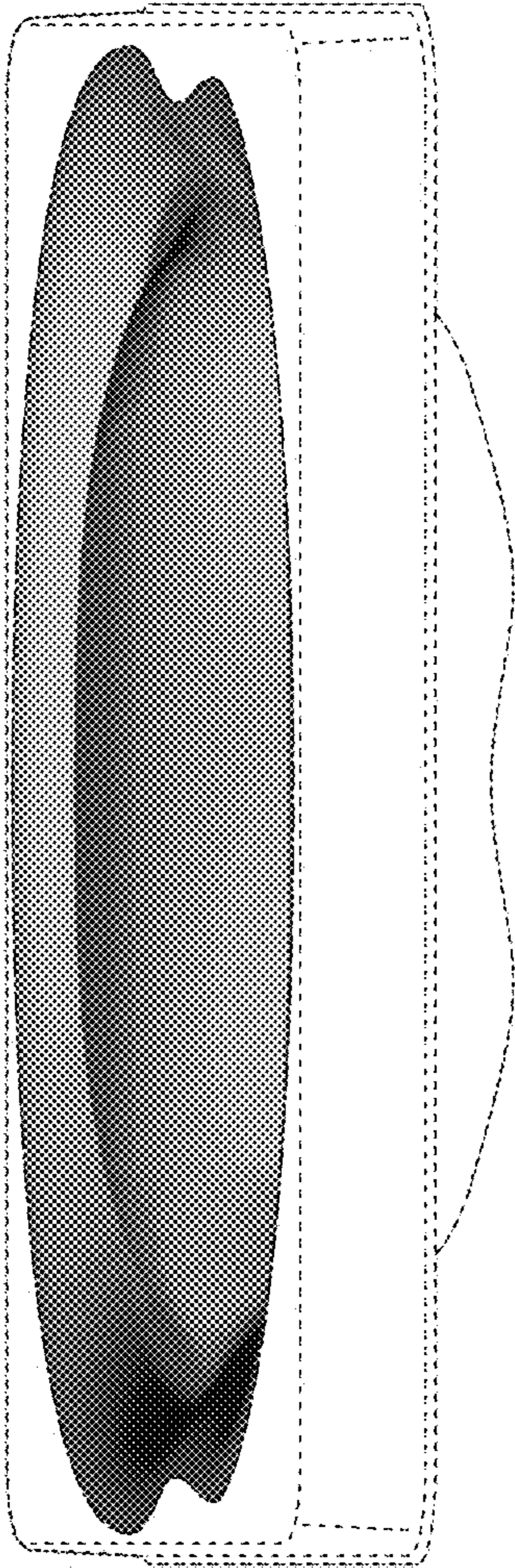


Fig. 2

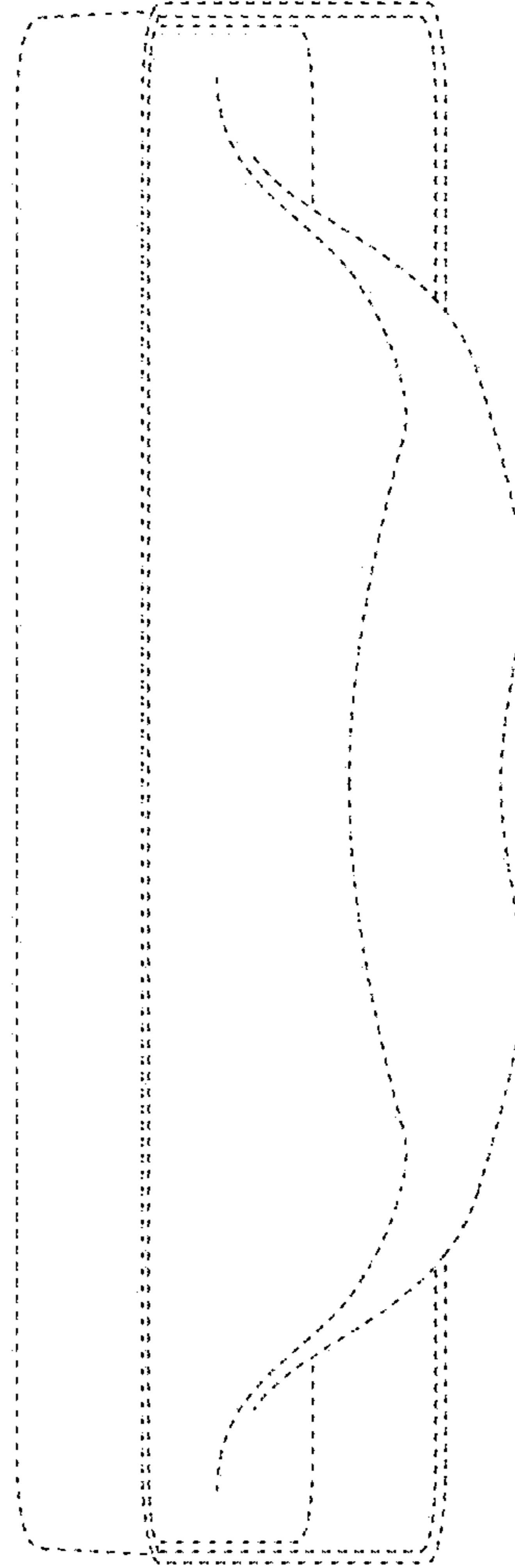


Fig. 3

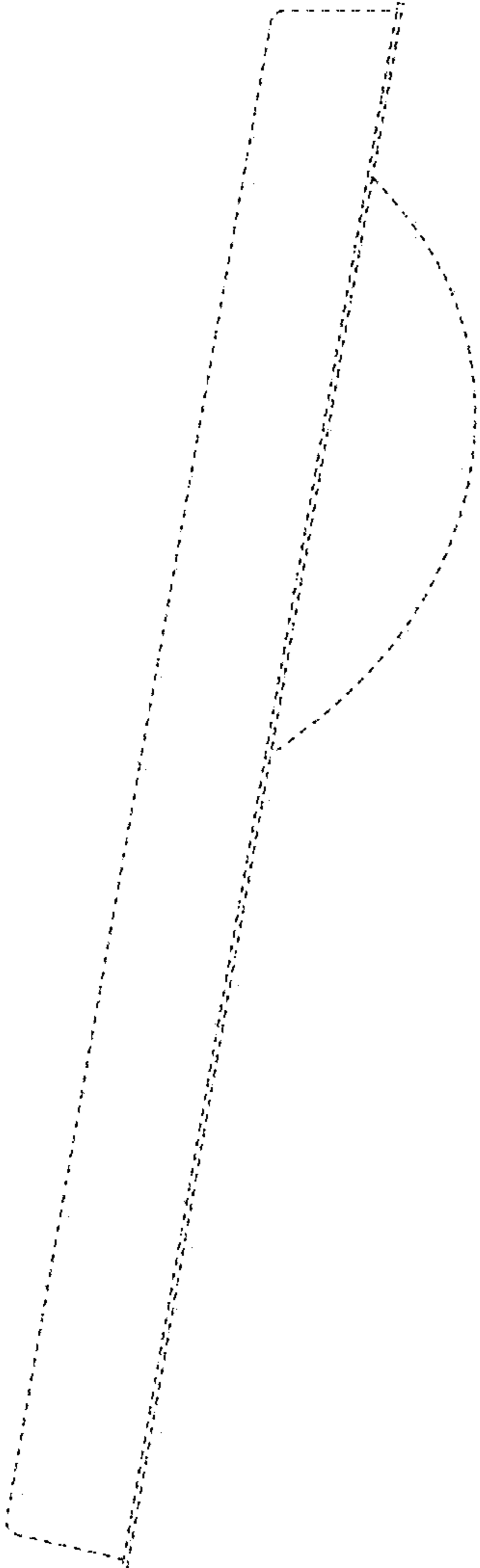


Fig. 4

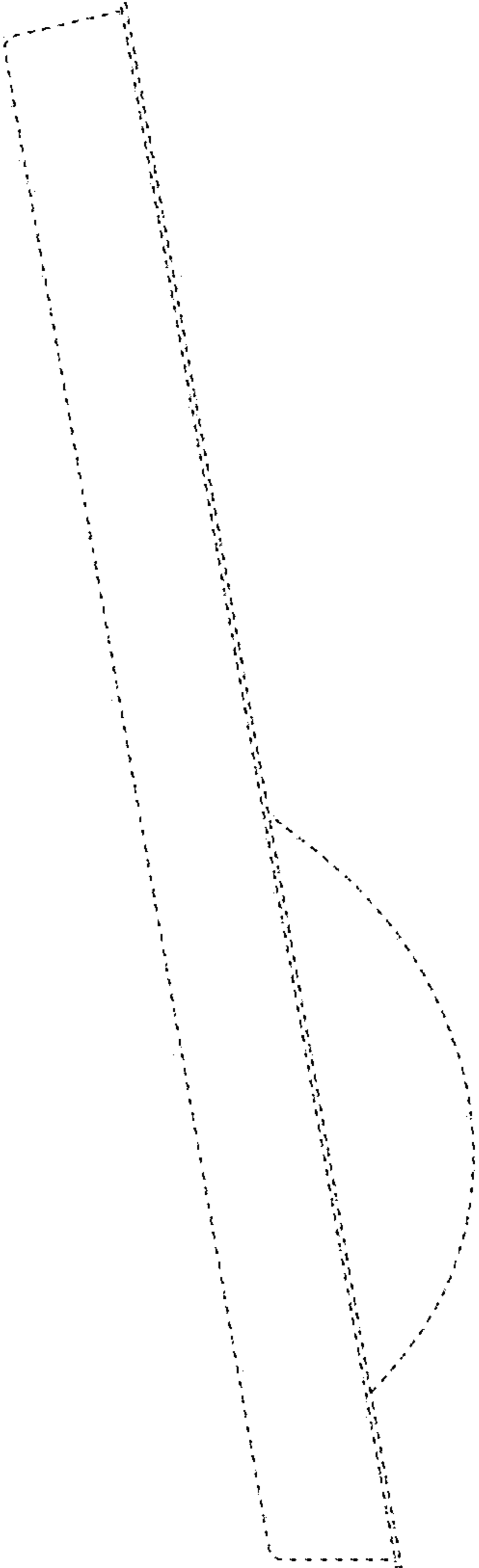


Fig. 5

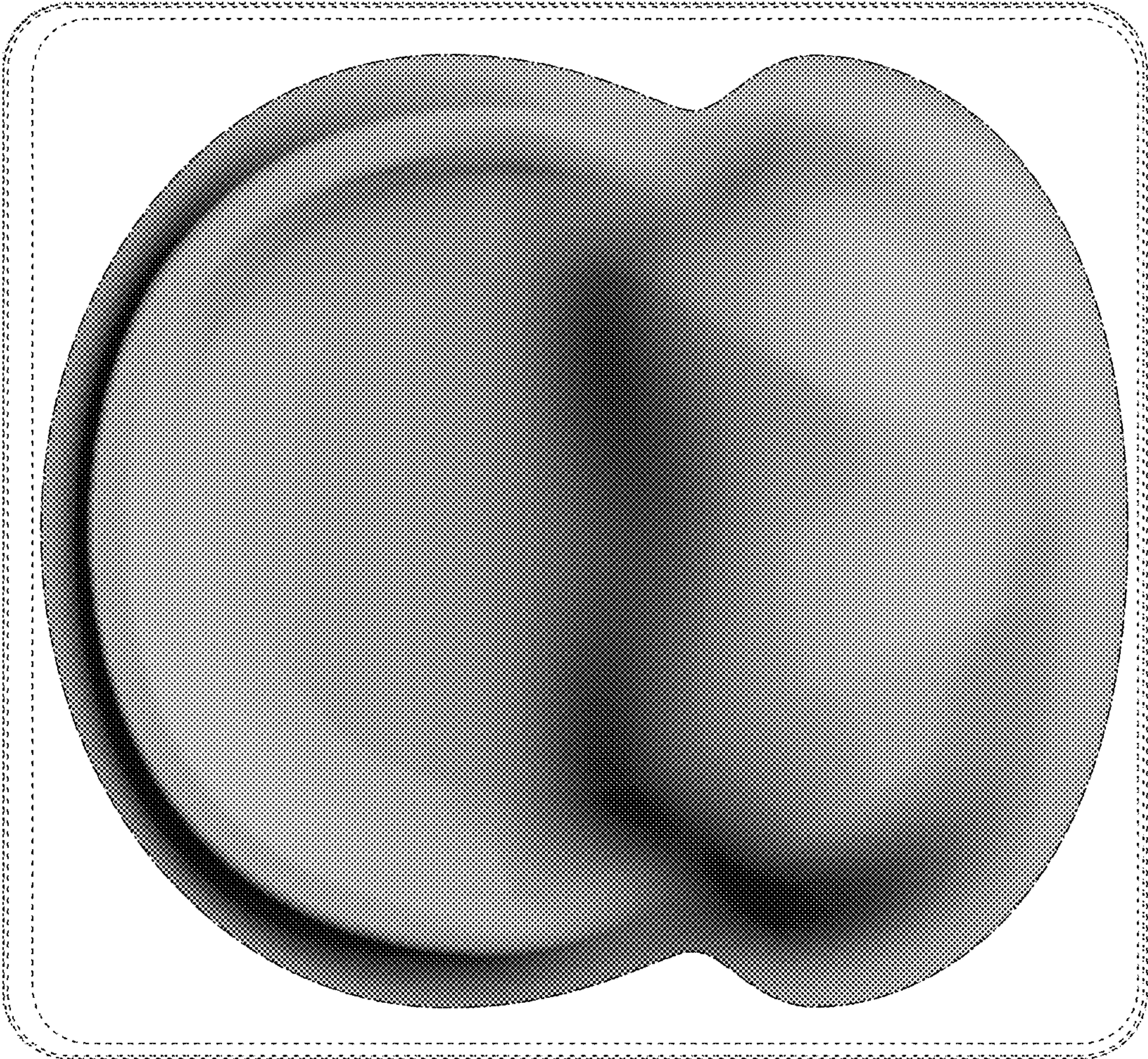


Fig. 6

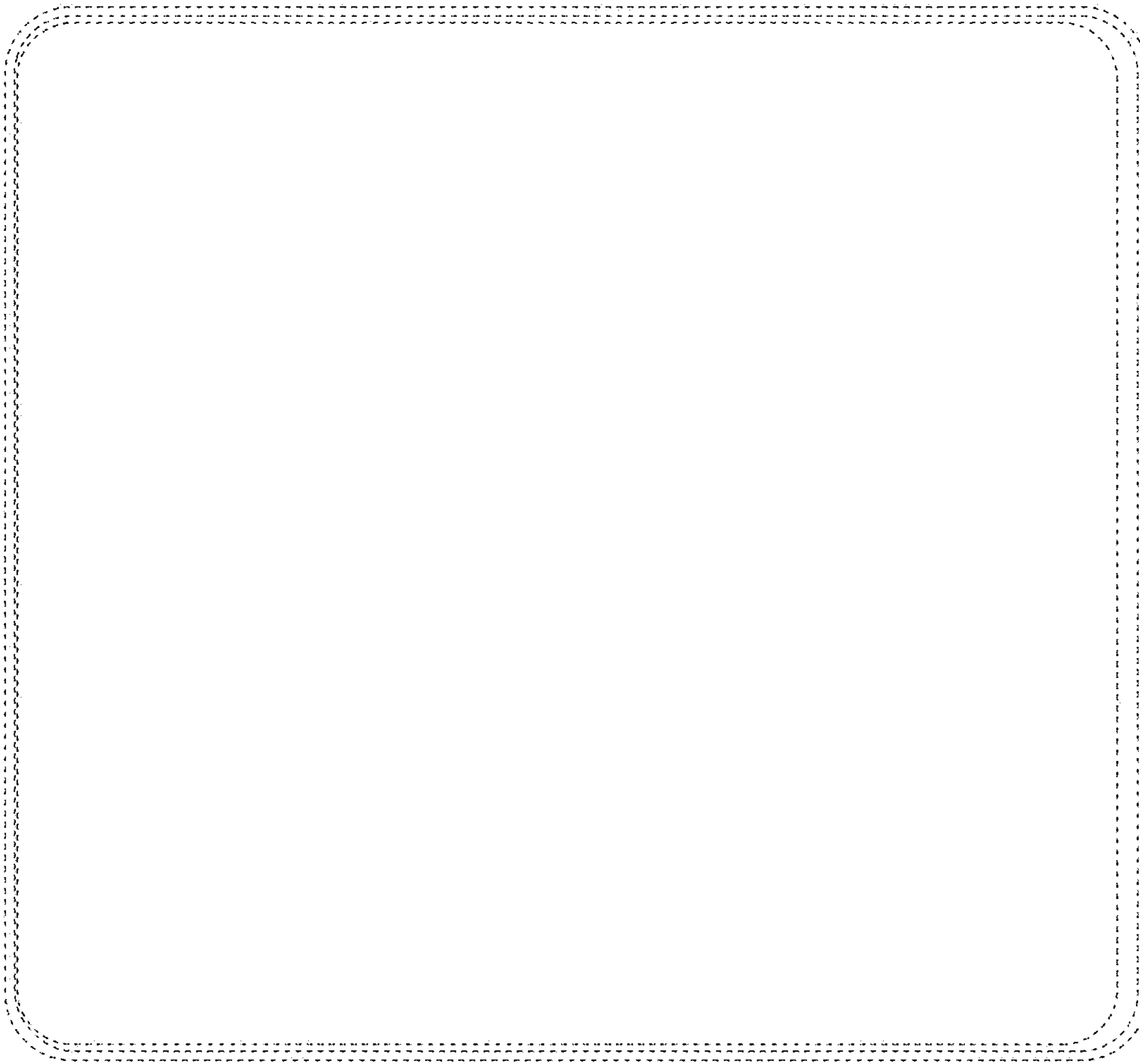


Fig. 7